

E-Filing

SUSMAN GODFREY L.L.P.
 MAX L. TRIBBLE, JR. (mtribble@susmangodfrey.com)
 JOSEPH S. GRINSTEIN (jgrinstein@susmangodfrey.com)
 IAN CROSBY (icrosby@susmangodfrey.com)
 1000 Louisiana Street, Suite 5100
 Houston, TX 77002-5096
 Telephone: (713) 651-9366
 Facsimile: (713) 654-6666

CONLEY ROSE, P.C.
 MICHAEL F. HEIM (mheim@townsend.com)
 RUSSELL A. CHORUSH (rchorush@townsend.com)
 600 Travis, Suite 7100
 Houston, TX 77002-2910
 Telephone: (713) 238-8000
 Facsimile: (713) 238-8008

TOWNSEND AND TOWNSEND AND CREW LLP
 GEORGE M. SCHWAB (State Bar No. 58250)
 gms@townsend.com
 GREGORY S. BISHOP (State Bar No. 184680)
 gsbishop@townsend.com
 APRIL ABELE (State Bar No. 180638)
 aeabele@townsend.com
 Two Embarcadero Center, 8th Floor
 San Francisco, California 94111
 Telephone: (415) 576-0200
 Facsimile: (415) 576-0300
 Attorneys for Plaintiff/Counterdefendant
 UniRAM TECHNOLOGY, INC.

UNITED STATES DISTRICT COURT
 FOR THE NORTHERN DISTRICT OF CALIFORNIA

SAN FRANCISCO DIVISION

UNIRAM TECHNOLOGY, INC.,


Plaintiff,

v.

MONOLITHIC SYSTEM TECHNOLOGY,
 INC., a Delaware corporation; TAIWAN
 SEMICONDUCTOR MANUFACTURING
 COMPANY, LTD., a Taiwan corporation; and
 TSMC NORTH AMERICA, a California
 corporation,

Defendants.

AND RELATED COUNTERCLAIMS.

Case No.  CV 04-1268 VRW

**[PROPOSED] ORDER GRANTING
 THE SEALING OF CERTAIN
 DOCUMENTS RELATED TO THE
 CLAIM CONSTRUCTION BRIEF OF
 TAIWAN SEMICONDUCTOR
 MANUFACTURING COMPANY
 LTD. AND TSMC NORTH
 AMERICA**

Hon. Vaughn R. Walker
 Courtroom 6, 17th Floor

[PROPOSED] ORDER GRANTING THE SEALING OF CERTAIN DOCUMENTS RELATED
 TO THE CLAIM CONSTRUCTION BRIEF OF TAIWAN SEMICONDUCTOR MANUFACTURING
 COMPANY, LTD. AND TSMC NORTH AMERICA

Case No. CV 04-1268 VRW

1 Having considered defendants Taiwan Semiconductor Manufacturing Company Ltd. and
2 TSMC North America Miscellaneous Administrative Request Pursuant to Civil Local Rules 7-10
3 and 79-5 to Seal Documents Relating to Their Claim Construction Brief, and the Declaration of
4 UniRAM Technology, Inc.'s Counsel in Support of Taiwan Semiconductor Manufacturing
5 Company Ltd. and TSMC North America Miscellaneous Administrative Request Pursuant to
6 Civil Local Rules 7-10 and 79-5 to Seal Documents Relating to Their Claim Construction Brief,
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8 IT IS HEREBY ORDERED AS FOLLOWS:

9 1. Taiwan Semiconductor Manufacturing Company Ltd. and TSMC North
10 America's Miscellaneous Administrative Request to Seal Documents Relating to Their Claim
11 Construction Brief is GRANTED.


12 2. The unredacted version of Taiwan Semiconductor Manufacturing Company, Ltd.
13 and TSMC North America's Claim Construction Brief shall be filed under seal;

14 3. Exhibit A to the Confidential Declaration of Brandon Conrad in Support of
15 Taiwan Semiconductor Manufacturing Company Ltd. And TSMC North America's Claim
16 Construction Brief ("Confidential Conrad Decl."), shall be filed under seal;

17 4. Exhibit B to the Confidential Conrad Decl. shall be filed under seal;

18 5. Exhibit C to the Confidential Conrad Decl. shall be filed under seal.

19 DATED: _____, 2005

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22 HON. VAUGHN R. WALKER
23 UNITED STATES DISTRICT JUDGE
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